IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:

CHAO, Yuan-Jen

Conf.:

Appl. No.:

NEW

Group:

Filed:

August 27, 2003

Examiner:

For:

MULTI-CHIP INTEGRATED MODULE

PRELIMINARY AMENDMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 August 27, 2003

Sir:

The following preliminary amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the Specification

Amendments to the Claims

Remarks